EPD-660-101/ EPD-662-101

13.3" ePaper Wifi Display Device



Features

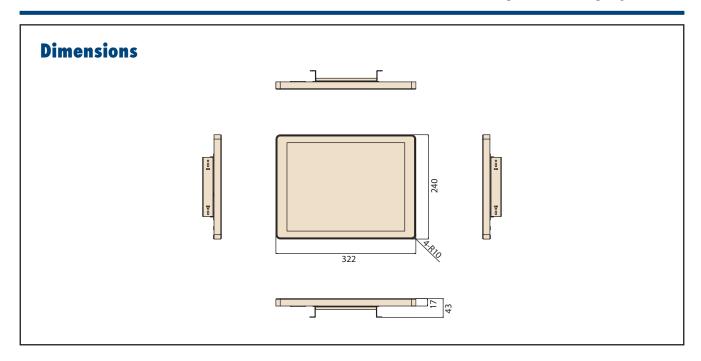
- ARM Cortex-M4 Core Processor
- Supports IEEE 802.11b/g/n
- 13.3" ePaper panel display
- Supports operation temperatures of 0 \sim 40 °C (Red/Black/White), 0 \sim 50 °C (Black/White)
- High performance integrated system
- Supports over-the-air upgrade (OTA)
- Solution with WISE-3220 Wi-Fi AP and ARK DeviceOn/ePaper

Introduction

Advantech EPD-660 and EPD-662 ePaper solutions support 2.4GHz RF wireless protocols integrated within a 13.3" display solution with ARM Cortex-M4 processor. EPD-660 and EPD-662 support optimized power consumption and device management, and a 2.4GHz Wi-Fi solution adaptable to diverse applications. Wireless ePaper offers RESTful APIs on DeviceOn/ePaper and system integrator can design different application.

EPD-132 Specifications

	MCU	ST 32-bit ARM Cortex-M4 Processor	
Computing System	Memory	RAM 256 KB	
	Screen Size	285.8 x 213.65 mm	
Display	Resolution	1600 x 1200 pixels	
٥.	Internal	ITE SPI Flash: 32Mb	
Storage	External	BM22 SPI Flash: 128Mb	
	Standard	IEEE 802.11b/g/n and Bluetooth Low Energy	
	Frequency Band	2.4000~2.4840 GHz for Wi-Fi 2.4000~2.4835 GHz for BT	
	Channels	1-11 for Wi-Fi 0-78 for BT 2.1+EDR 0-39 for BLE	
Wireless Network	Transmit Power	Typ. 14 dBm at 802.11b CCK Mode 1M Typ. 12 dBm at 802.11g OFDM Mode 54M Typ. 12 dBm at 802.11n OFDM Mode MCS0 Typ. 5 dBm for BLE (class 1.5)	
	Receiver Sensitivity	Typ95dBm at 1 Mbps Typ75 dBm at 54 Mbps Typ89 dBm at MCSO Typ89 dBm for BLE	
	Function	End node	
	Antenna connector	MHF	
	Antenna	PCB Antenna	
Power	DC 5V	Micro USB (CN2) up to 0.9A/4.5 W in USB3.0 host Micro USB (CN3) up to 2A/10 W	Data transmission mode with power supply
Tower	Power consumption	Standby: 18mA / 90mW Application: 0.25A / 1.25W	
	Operational Temperature	0 ~ 40 °C (Red/Black/White), 0 ~ 50 °C (Black/White)	
Environment	Non-Operational Temp.	-25 ~ 60 °C (R/B/W) , -25 ~ 70 °C (B/W)	
LIIVIIOIIIIIGIIL	Assembly Temperature	10 ~ 40 °C	
	Operating Humidity	5 ~ 85% Relative Humidity, non-condensing	
	Material Type	Metal (NCT)	
Housing Mechanical	Painting Type	SECC+ Painting	
Trodomy Moonamod	Dimension	240 x 322 x 60.5 mm/ 240 x 322 x 24 mm	
	Weight	1.3kg	
Physical Characteristics	Dimensions (W x H)	Panel: 285.8 x 213.65 mm PCBA: 108 x 122 x 3.9 mm	
i nysicai onaractensiles	Weight	Panel: 0.12g PCBA: 0.17g	
Operating System		ThreadX v5.6	



Ordering Information

Part No.	Description
EPD-132R2AG-NSD01	13.3" Red/Black/White ePaper Wi-Fi display device in 2.4G
EPD-132B2AG-NSD01	13.3" Black/White ePaper Wi-Fi display device in 2.4G

Development Kit Ordering Information

	Model Name	Description
EPD device	EPD-662-101	13.3" Red/Black/White ePaper Wi-Fi display device in 2.4G
ELD MENICE	EPD-660-101	13.3" Black/White ePaper Wi-Fi display device in 2.4G
	WISE-3220IOS-21A1E	Wi-Fi AP and configuration router for EU
	WISE-3220IOS-21A1J	Wi-Fi AP and configuration router for JP
Router	WISE-3220IOS-21A1N	Wi-Fi AP and configuration router for NA
	WISE-3220IOS-21A1T	Wi-Fi AP and configuration router for TW
	WISE-3220IOS-21A1C	Wi-Fi AP and configuration router for China
DeviceOn/ePaper Server	ARK-1123H-EP2A2 for entry-level use: Ubuntu 20.04/128G SSD/8G RAM and build in DeviceOn/ePaper with 50 connection licenses ARK-2250L-EP1A2 for enterprises: Ubuntu 20.04/1T HD/16G RAM and build in DeviceOn/ePaper with 500 connection licenses	

 $^{^{\}star} \ \, \text{Ordering EPD device, WISE-3220, and ARK DeviceOn/ePaper Server one each to try Advantech wireless EPD displayl solution}$

Packing List

Model Name	Part No.	Description
EPD-660-101	EPD-132B2AG-NSD01	1. 13.3" Black/White ePaper Device 2. Mirco USB cable 60cm x1
EPD-662-101	EPD-132R2AG-NSD01	1. 13.3" Red/Black/White ePaper Device

^{*} All Eink Panel inspection criteria refer to Eink CAS & Inspection standard document.

Optional Accessories

Model Name	Description	
1960094460N001	Wall mount bracket	

All Ellik Pariet in Specifion Criteria Free to Ellik CAS & Ill Specifion Standard document.

Note: E Ink Recommend condition for storage:
Temperature: 20 +-10 degree C
Humidity: 60% RH+-10%RH, Non-condensing

Note: If panel module has been put in low temperature between 0--25 degree C for a while, we recommend leaving it between 20 to 30 degree C for 4 days before assembly.